

DATASHEET

SMD ■ B 42-21/BHC-AUW/1T



Features

- Package in 8mm tape on 7" diameter reel.
- Compatible with automatic placement equipment.
- Compatible with infrared and vapor phase reflow solder process.
- Mono-color type.
- Pb-free.
- The product itself will remain within RoHS compliant version.

Description

- The 42-21 SMD LED is much smaller than lead frame type components, thus enable smaller board ize, higher packing density, reduced storage space and finally smaller equipment to be obtained.
- Besides, lightweight makes them ideal for miniature applications. etc.

Applications

- Telecommunication: indicator and backlighting in telephone and fax.
- Flat backlight for LCD, switch and symbol.
- General use.



Device Selection Guide

Chip Materials	Emitted Color	Resin Color
InGaN	Blue	Water clear

Absolute Maximum Ratings (Ta=25℃)

Parameter	Symbol	Rating	Unit	
Reverse Voltage	V_R	5	V	
Forward Current	I _F	25	mA	
Peak Forward Current (Duty 1/10 @1KHz)	I _{FP}	100	mA	
Power Dissipation	Pd	95	mW	
Operating Temperature	T_{opr}	-40 ~ +85	${\mathbb C}$	
Storage Temperature	Tstg	-40 ~ +90	$^{\circ}\! \mathbb{C}$	
Electrostatic Discharge	ESD _{HBM}	150	V	
Soldering Temperature	T _{sol}	Reflow Soldering : 260 $^\circ\mathbb{C}$ for 10 sec. Hand Soldering : 350 $^\circ\mathbb{C}$ for 3 sec.		

Electro-Optical Characteristics (Ta=25℃)

Parameter	Symbol	Min.	Тур.	Max.	Unit	Condition
Luminous Intensity	lv	450		1800	mcd	I _F =20mA
Viewing Angle	2θ _{1/2}		30		deg	I _F =20mA
Peak Wavelength	λ_{p}		468		nm	I _F =20mA
Dominant Wavelength	$\lambda_{ m d}$	464.5		476.5	nm	I _F =20mA
Spectrum Radiation Bandwidth	Δλ		25		nm	I _F =20mA
Forward Voltage	V_{F}	2.7	3.3	3.7	V	I _F =20mA
Reverse Current	I _R			50	μA	V _R =5V

Notes:

- 1.Tolerance of Luminous Intensity ±11nm
- 2. Tolerance of Dominant Wavelength ± 1 nm



Bin Range of Luminous Intensity

Bin Code	Min.	Max.	Unit	Condition
U	450	715		_
V	715	1120	mcd	$I_{\rm F} = 20 \rm mA$
W	1120	1800		

Note:

Tolerance of Luminous Intensity: ±11%

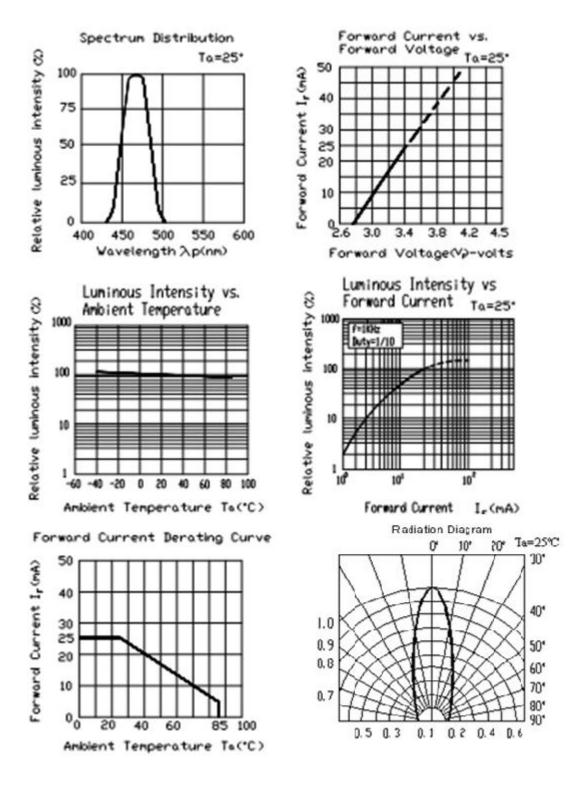
Bin Range of Dominant Wavelength

Group	Bin Code	Min.	Max.	Unit	Condition
A9 A10 A11 A12	A9	464.5	467.5		
	A10	467.5	470.5		I 00 ··· A
	A11	470.5	473.5	mm nm	$I_F = 20 \text{mA}$
	A12	473.5	476.5		

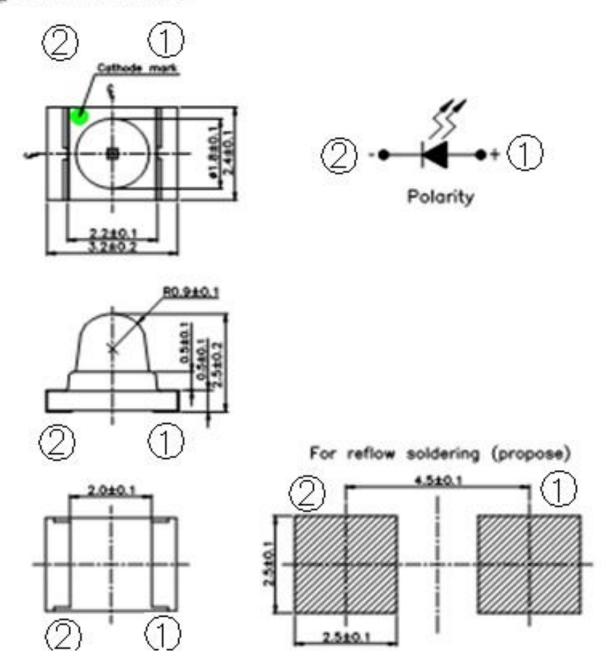
Notes:

- 1.Tolerance of Luminous Intensity ±11%
- 2. Tolerance of Dominant Wavelength ±1nm

Typical Electro-Optical Characteristics Curves



Package Outline Dimensions

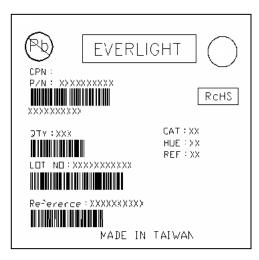


Suggested pad dimension is just for reference only. Please modify the pad dimension based on individual need.

Note: The tolerances unless mentioned is ± 0.1 mm, Unit = mm

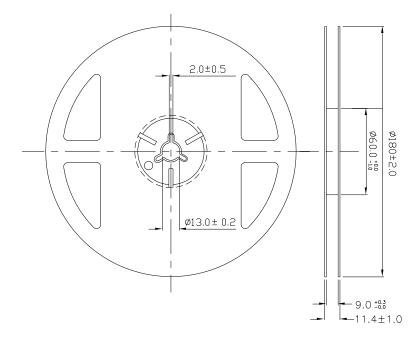


Moisture Resistant Packing Materials Label Explanation



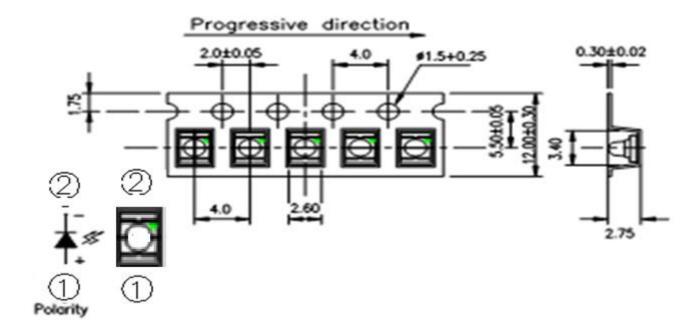
- CPN: Customer's Product Number
- P/N: Product Number
- · QTY: Packing Quantity
- · CAT: Luminous Intensity Rank
- HUE: Chromaticity Coordinates & Dom. Wavelength Rank
- REF: Forward Voltage Rank
- · LOT No: Lot Number

Reel Dimensions



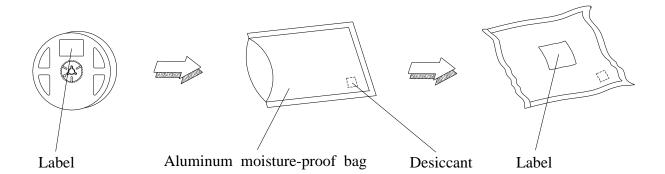
Note: The tolerances unless mentioned is ± 0.1 mm, Unit = mm

Carrier Tape Dimensions: Loaded quantity 1000 PCS per reel



Note: The tolerances unless mentioned is ± 0.1 mm, Unit = mm

Moisture Resistant Packaging





Precautions For Use

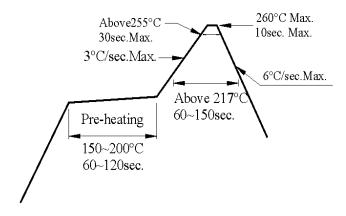
1. Over-current-proof

Customer must apply resistors for protection, otherwise slight voltage shift will cause big current change (Burn out will happen).

- 2. Storage
- 2.1 Do not open moisture proof bag before the products are ready to use.
- 2.2 Before opening the package: The LEDs should be kept at 30°C or less and 90%RH or less.
- 2.3 After opening the package: The LED's floor life is 1 year under 30°C or less and 60% RH or less.

 If unused LEDs remain, it should be stored in moisture proof packages.
- 2.4 If the moisture absorbent material (silica gel) has faded away or the LEDs have exceeded the storage time, baking treatment should be performed using the following conditions.

 Baking treatment: 60±5°C for 24 hours.
- 3. Soldering Condition
 - 3.1 Pb-free solder temperature profile



- 3.2 Reflow soldering should not be done more than two times.
- 3.3 When soldering, do not put stress on the LEDs during heating.
- 3.4 After soldering, do not warp the circuit board.

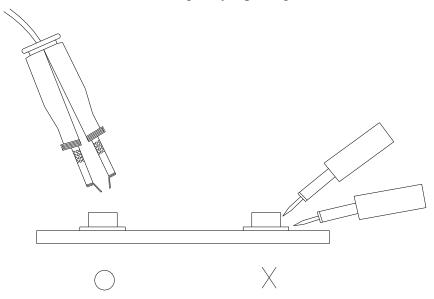


4. Soldering Iron

Each terminal is to go to the tip of soldering iron temperature less than 350°C for 3 seconds within once in less than the soldering iron capacity 25W. Leave two seconds and more intervals, and do soldering of each terminal. Be careful because the damage of the product is often started at the time of the hand solder.

5.Repairing

Repair should not be done after the LEDs have been soldered. When repairing is unavoidable, a double-head soldering iron should be used (as below figure). It should be confirmed beforehand whether the characteristics of the LEDs will or will not be damaged by repairing.



EVERLIGHT ELECTRONICS CO., LTD.

Office: No 25, Lane 76, Sec 3, Chung Yang Rd, Tucheng, Taipei 236, Taiwan, R.O.C Tel: 886-2-2267-2000, 2267-9936

Fax: 886-2267-6244, 2267-6189, 2267-6306

http://www.everlight.com



Application Restrictions

High reliability applications such as military/aerospace, automotive safety/security systems, and medical equipment may require different product. If you have any concerns, please contact Everlight before using this product in your application. This specification guarantees the quality and performance of the product as an individual component. Do not use this product beyond the specification described in this document.

AMEYA360 Components Supply Platform

Authorized Distribution Brand:

























Website:

Welcome to visit www.ameya360.com

Contact Us:

Address:

401 Building No.5, JiuGe Business Center, Lane 2301, Yishan Rd Minhang District, Shanghai , China

> Sales:

Direct +86 (21) 6401-6692

Email amall@ameya360.com

QQ 800077892

Skype ameyasales1 ameyasales2

Customer Service :

Email service@ameya360.com

Partnership :

Tel +86 (21) 64016692-8333

Email mkt@ameya360.com